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**ON Semiconductor®** 

# **FDMC4435BZ** P-Channel Power Trench<sup>®</sup> MOSFET -30 V, -18 A, 20 m $\Omega$

#### Features

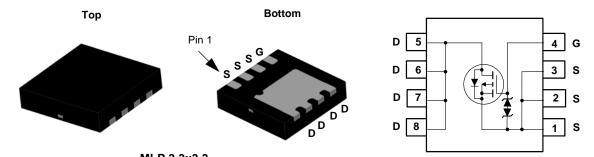
- Max  $r_{DS(on)}$  = 20 m $\Omega$  at V<sub>GS</sub> = -10 V, I<sub>D</sub> = -8.5 A
- Max  $r_{DS(on)}$  = 37 m $\Omega$  at V<sub>GS</sub> = -4.5 V, I<sub>D</sub> = -6.3 A
- Extended V<sub>GSS</sub> range (-25 V) for battery applications
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- High power and current handling capability
- HBM ESD protection level >7 kV typical (Note 4)
- 100% UIL Tested
- Termination is Lead-free and RoHS Compliant

### **General Description**

This P-Channel MOSFET is produced using ON Semiconductor's advanced Power Trench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.

#### Applications

- High side in DC DC Buck Converters
- Notebook battery power management
- Load switch in Notebook



MLP 3.3x3.3

## MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			-30	V	
V <sub>GS</sub>	Gate to Source Voltage			±25	V	
	Drain Current -Continuous	T <sub>C</sub> = 25 °C		-18		
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	-8.5	Α	
	-Pulsed			-50		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	32	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		31	w	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.3	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

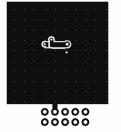
## **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		4	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	53	C/VV

### **Package Marking and Ordering Information**

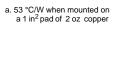
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC4435BZ	FDMC4435BZ	MLP 3.3X3.3	13 "	12 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = -250 μA, V <sub>GS</sub> = 0 V	-30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$ , referenced to 25 °C		21		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -24 \text{ V},$ $V_{GS} = 0 \text{ V},$ $T_{J} = 125 \text{ °C}$			-1 -100	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA
On Chara	acteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = -250 μA	-1.0	-1.8	-3.0	V
$\Delta V_{GS(th)}$ $\Delta T_{J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$ , referenced to 25 °C		-5		mV/°C
J		V <sub>GS</sub> = -10 V, I <sub>D</sub> = -8.5 A		14	20	mΩ
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = -4.5 \text{ V}, I_D = -6.3 \text{ A}$		21	37	
		V <sub>GS</sub> = -10 V, I <sub>D</sub> = -8.5 A, T <sub>J</sub> = 125 °C		20	29	- 11152
9fs	Forward Transconductance	$V_{DD} = -5 V, I_D = -8.5 A$		25		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			1535	2040	pF
C <sub>oss</sub>	Output Capacitance	−V <sub>DS</sub> = -15 V, V <sub>GS</sub> = 0 V, _ f = 1 MHz		310	410	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			280	420	pF
R <sub>g</sub>	Gate Resistance	f = 1 MHz		4		Ω
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			10	20	ns
<b>G</b> (OD)				9	18	ns
t <sub>r</sub>	Rise Time	V <sub>D</sub> = -15 V, I <sub>D</sub> = -8.5 A,		0		
t <sub>r</sub>	Rise Time Turn-Off Delay Time	$V_{DD}$ = -15 V, I <sub>D</sub> = -8.5 A, V <sub>GS</sub> = -10 V, R <sub>GEN</sub> = 6 Ω		35	56	ns
				-	-	ns ns
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-Off Delay Time			35	56	
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub>	Turn-Off Delay Time Fall Time	$V_{GS} = -10 \text{ V}, \ \overline{R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } -10 \text{ V}$ $V_{GS} = 0 \text{ V to } -4.5 \text{ V}$ $V_{DD} = -15 \text{ V},$		35 19	56 34	ns
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub>	Turn-Off Delay Time         Fall Time         Total Gate Charge	$V_{GS} = -10 \text{ V},  \text{R}_{\text{GEN}} = 6 \Omega$		35 19 38	56 34 53	ns nC
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub>	Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge	$V_{GS} = -10 \text{ V}, \ \overline{R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } -10 \text{ V}$ $V_{GS} = 0 \text{ V to } -4.5 \text{ V}$ $V_{DD} = -15 \text{ V},$		35 19 38 20	56 34 53	ns nC nC
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge	$V_{GS} = -10 \text{ V}, \ \overline{R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } -10 \text{ V}$ $V_{GS} = 0 \text{ V to } -4.5 \text{ V}$ $V_{DD} = -15 \text{ V},$		35 19 38 20 4.3	56 34 53	ns nC nC nC
$\begin{array}{c} t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_g \\ Q_{gs} \\ Q_{gd} \\ \end{array}$	Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics	$V_{GS} = -10 \text{ V}, \ \overline{R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } -10 \text{ V}$ $V_{GS} = 0 \text{ V to } -4.5 \text{ V}$ $V_{DD} = -15 \text{ V},$		35 19 38 20 4.3	56 34 53	ns nC nC nC
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Turn-Off Delay TimeFall TimeTotal Gate ChargeTotal Gate ChargeGate to Source ChargeGate to Drain "Miller" Charge	$V_{GS} = -10 \text{ V}, \ \overline{R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } -10 \text{ V}$ $V_{GS} = 0 \text{ V to } -4.5 \text{ V}$ $V_{DD} = -15 \text{ V},$ $I_{D} = -8.5 \text{ A}$		35 19 38 20 4.3 11	56 34 53 28	ns nC nC nC
$\begin{array}{c} t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_g \\ Q_{gs} \\ Q_{gd} \\ \end{array}$	Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics	$V_{GS} = -10 \text{ V}, \ \overline{R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } -10 \text{ V}$ $V_{DD} = -15 \text{ V},$ $I_D = -8.5 \text{ A}$ $V_{GS} = 0 \text{ V}, \ I_S = -8.5 \text{ A}$ (Note 2)		35 19 38 20 4.3 11	56 34 53 28 1.5	ns nC nC nC



2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0 %.

3. Starting  $T_J$  = 25°C; P-ch: L = 1mH,  $I_{AS}$  = -8A,  $V_{DD}$  = -27V,  $V_{GS}$  = -10V.



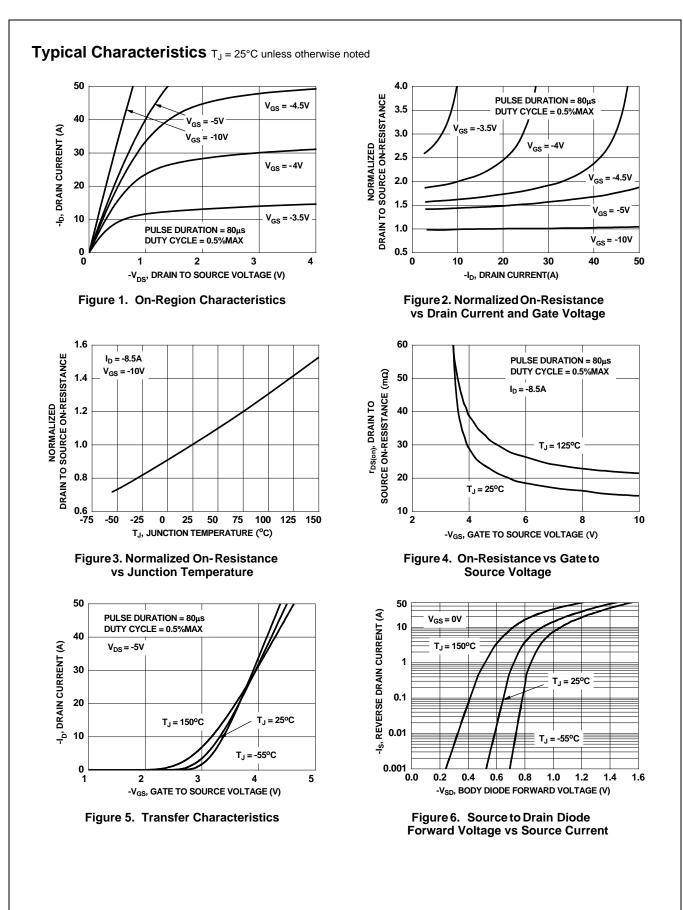
4. The diode connected between the gate and source servers only as protection against ESD. No gate overvoltage rating is implied.

b.125 °C/W when mounted on a minimum pad of 2 oz copper

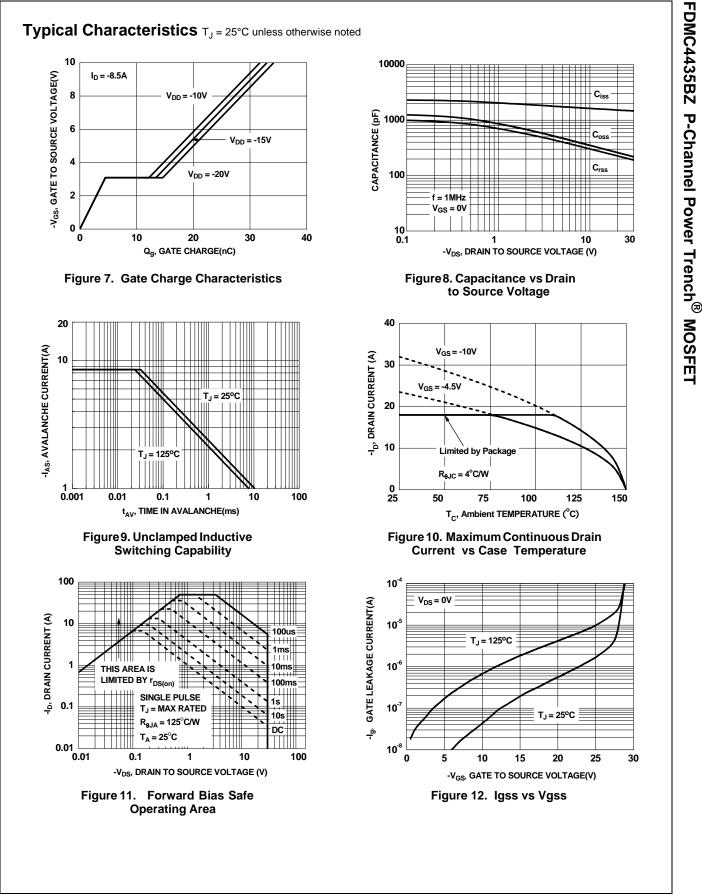
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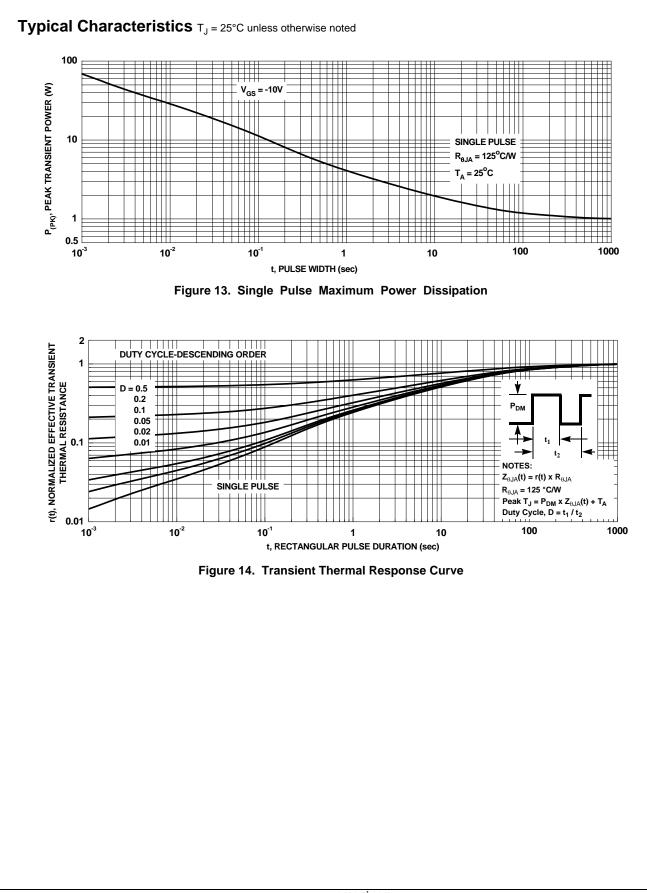
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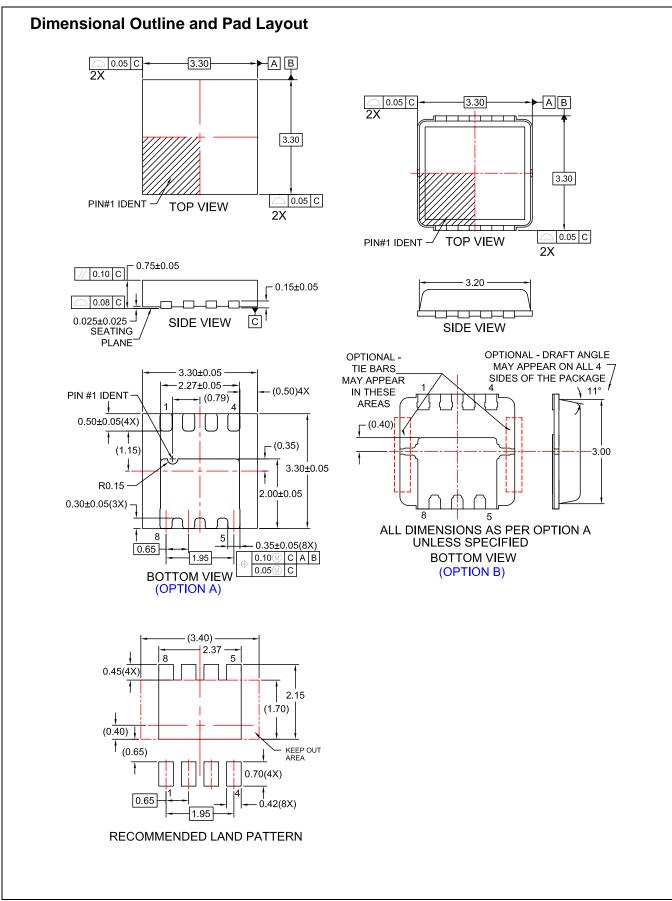
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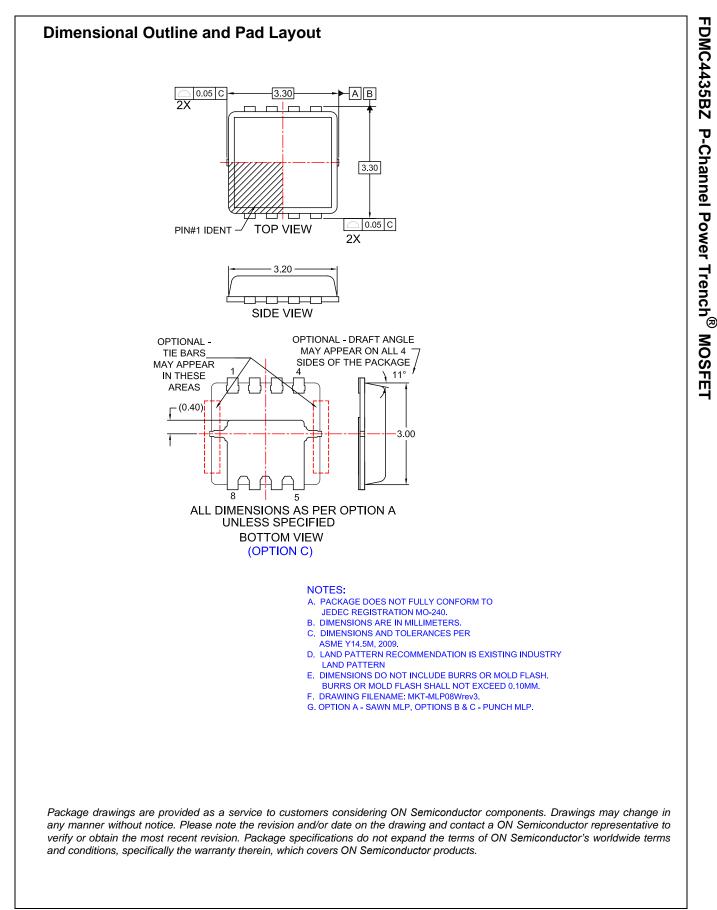
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